

Chapter 26

Introduction to Semiconductors

Semiconductor Basics

- Atoms
 - Protons
 - Neutrons
 - Electrons

Semiconductor Basics

- Electron shells: K, L, M, N, etc.
 - Conductor
 - 1 electron in outer shell (valence shell)
 - Insulator
 - 8 in valence shell (outer shell full)
 - Semiconductor
 - 4 in valence shell

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Semiconductor Basics

- Most common semiconductors
 - Silicon (Si)
 - Germanium (Ge)

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Semiconductor Basics

- Valence electrons have greatest energy
- Electrons have discrete energy levels that correspond to orbits

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Semiconductor Basics

- Valence electrons have two energy levels
 - Valence Band
 - Lower energy level
 - Conduction Band
 - Higher energy level

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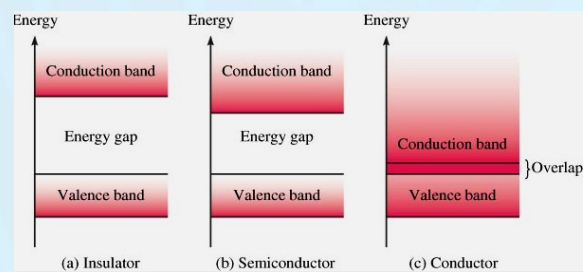
Semiconductor Basics

- Differences in energy levels provide
 - Insulators
 - Semiconductors
 - Conductors

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Semiconductor Basics

- Energy gap between Valence and Conduction Bands



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Semiconductor Basics

- Conductor has many “free” electrons
- These are called “conduction” electrons
- Energy Gap is between valence and conduction band

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Semiconductor Basics

- Atomic Physics
 - Energy expressed in electron volts (eV)
 - $1 \text{ eV} = 1.602 \times 10^{-19} \text{ joules}$
- Energy gap
 - Small for conductors
 - Large for insulators

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Semiconductor Basics

- Silicon has 4 electrons in its valence shell
- 8 electrons fill the valence shell
- Silicon forms a lattice structure and adjacent atoms “share” valence electrons

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Semiconductor Basics

- Electrons are shared so each valence shell is filled (8 electrons)
- Valence shells full
 - No “free” electrons at 0 K

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Conduction in Semiconductors

- At temperatures $> 0^\circ \text{K}$
 - Some electrons move into conduction band
- Electron-Hole pairs are formed
 - Hole is vacancy left in lattice by an electron that moves into conduction band
 - Continuous recombination occurs

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Conduction in Semiconductors

- Electrons available for conduction
 - Copper $\approx 10^{23}$
 - Silicon $\approx 10^{10}$ (poor conductor)
 - Germanium $\approx 10^{12}$ (poor conductor)

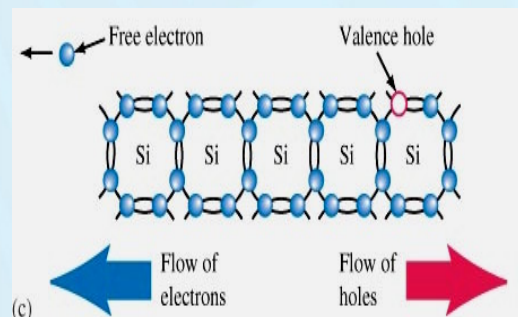
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Conduction in Semiconductors

- Hole: absence of an electron in the lattice structure
 - Electrons move from – to +
 - Holes (absence of electrons) move from + to –
 - Recombination
 - When an electron fills a hole

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Conduction in Semiconductors



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Conduction in Semiconductors

- As electrons move toward + terminal
 - Recombine with holes from other electrons
 - Electron current is mass movement of electrons
 - Hole current is mass movement of holes created by displaced electrons

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Conduction in Semiconductors

- Effect of temperature
 - Higher energy to electrons in valence band
 - Creates more electrons in conduction band
 - Increases conductivity and reduces resistance
 - Semiconductors have a negative temperature coefficient (NTC)

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Doping

- Adding impurities to semiconductor
 - Creates more free electron/hole pairs
 - Greatly increased conductivity
 - Known as “doping”

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Doping

- Terminology
 - Pure semiconductor known as intrinsic
 - Doped semiconductor known as extrinsic

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Doping

- Creates *n*-type or *p*-type semiconductors
 - Add a few ppm (parts per million) of doping material
 - *n*-type
 - More free electrons than holes
 - *p*-type
 - More holes than free electrons

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Doping

- Creating *n*-type semiconductors
 - Add (dope with) atoms with 5 valence electrons
 - Pentavalent atoms
 - Phosphorous (P)
 - Arsenic (As)
 - Antimony (Sb) – Group V on periodic table

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Doping

- Creating *n*-type semiconductors
 - New, donor atoms become part of lattice structure
 - Extra electron available for conduction

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Doping

- Intrinsic semiconductors
 - Equal number of holes and electrons
 - Conduction equally by holes and electrons
 - Very poor conductors (insulators)

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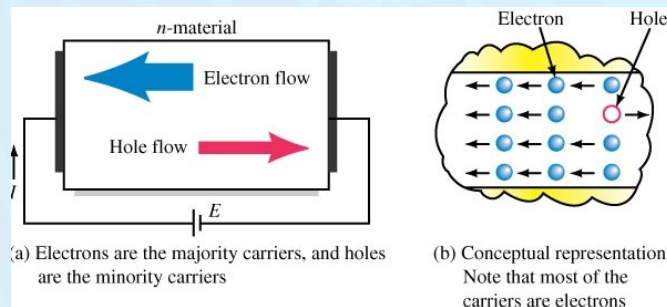
Doping

- *n*-type extrinsic semiconductor
 - Free electrons greatly outnumber free holes
 - Conduction primarily by electrons
 - Electrons are the “majority” carriers

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Doping

- Conduction in an *n*-type semiconductor



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Doping

- Creating p -type semiconductors
 - Add (dope with) atoms with 3 valence electrons
 - Trivalent atoms
 - Boron (B)
 - Aluminum (Al)
 - Gallium (Ga) – Group III on periodic table

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Doping

- Creating p -type semiconductors
 - New, acceptor atoms become part of lattice structure
 - Extra hole available for conduction

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Doping

- p -type extrinsic semiconductor
 - Free holes greatly outnumber free electrons
 - Conduction primarily by holes
 - Holes are the “majority” carriers
 - Electrons are the “minority” carriers

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The p - n Junction

- Abrupt transition from p -type to n -type material
- Creation
 - Must maintain lattice structure
 - Use molten or diffusion process

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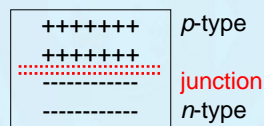
The p - n Junction

- Example
 - Heat n -type material to high temperature
 - Boron gas diffuses into material
 - Only upper layer becomes p -type
 - p - n junction created without disturbing lattice structure

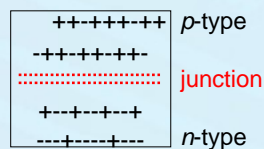
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The p - n Junction

- Joined p -type and n -type semiconductors



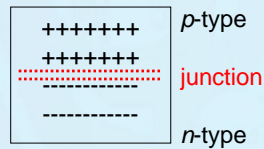
- Diffusion across junction creates barrier potential



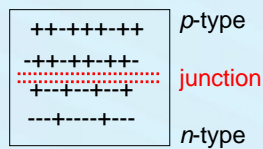
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The p - n Junction

- Joined p -type and n -type semiconductors



- Diffusion across junction creates barrier potential



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The p - n Junction

- Depletion region
- Barrier voltage, V_B
- Silicon
 - $V_B \approx 0.7$ volts at 25°C

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The p - n Junction

- Germanium
 - $V_B \approx 0.3$ volts at 25°C
- V_B must be overcome for conduction
- External source must be used

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The Biased p - n Junction

- Basis of semiconductor devices
- Diode
 - Unidirectional current
 - Forward bias (overcome V_B) – conducts easily
 - Reverse bias – virtually no current
 - p -type end is anode (A)

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The Biased p - n Junction

- Diode
 - n -type end is cathode (K)
 - Anode and cathode are from vacuum tube terminology

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The Biased p - n Junction

- Diode symbol
 - Arrow indicates direction of conventional current for condition of forward bias (A +, K -)
 - External voltage source required
 - External resistance required to limit current

Anode (A)  Cathode (K)

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The Biased p - n Junction

- Holes are majority carriers in p -type
- Electrons are majority carriers in n -type

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The Biased p - n Junction

- Reverse biased junction
 - Positive (+) terminal draws n -type majority carriers away from junction
 - Negative (–) terminal draws p -type majority carriers away from junction
 - No majority carriers attracted toward junction
 - Depletion region widens

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The Biased p - n Junction

- Electrons are minority carriers in p -type
- Holes are minority carriers in n -type
- Reverse biased junction
 - Minority carriers drawn across junction
 - Very few minority carriers

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The Biased p - n Junction

- Reverse biased current
 - Saturation current, I_S
 - Nanoamp-to-microamp range for signal diodes

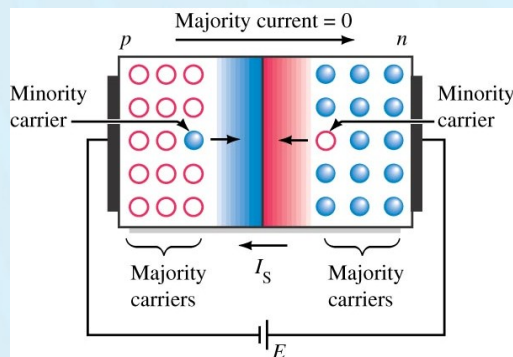
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The Biased p - n Junction

- Reverse biased junction
 - Positive terminal of source connected to cathode (n -type material)

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The Biased p - n Junction



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The Biased p - n Junction

- p -type
 - Holes are majority carriers
- n -type
 - Electrons are majority carriers

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The Biased p - n Junction

- Forward biased junction
 - + terminal draws n -type majority carriers toward junction
 - – terminal draws p -type majority carriers toward junction
 - Minority carriers attracted away from junction
 - Depletion region narrows

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The Biased p - n Junction

- Forward biased junction
 - Majority carriers drawn across junction
 - Current in n -type material is electron current
 - Current in p -type material is hole current
 - Current is referred to as I_{majority} or I_F (for forward current)

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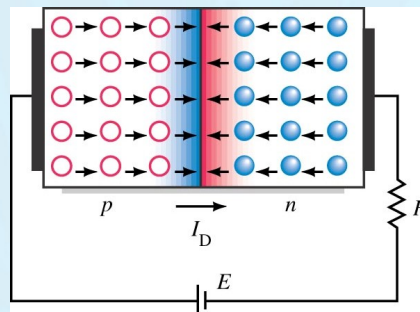
The Biased p - n Junction

- Voltage across Forward biased diode $\approx V_B$
 - Often referred to as V_F (for forward voltage)
 - $V_B \approx 0.7$ for Silicon and 0.3 for Germanium
- Forward biased current
 - Majority and Minority current
 - Minority current negligible

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The Biased p - n Junction

- Forward biased junction
 - Positive terminal of source connected to Anode (p -type material)



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The Biased p - n Junction

- Forward biased junction
 - Conducts when E exceeds V_B
 - For $E < V_B$ very little current flows
 - Total current = majority + minority current
 - Diode current, $I_F \approx$ majority current
 - $V_F \approx 0.7$ volts for a silicon diode

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Other Considerations

- Junction Breakdown
 - Caused by large reverse voltage
 - Result is high reverse current
 - Possible damage to diode
- Two mechanisms
 - Avalanche Breakdown
 - Zener Breakdown

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Other Considerations

- Avalanche Breakdown
 - Minority carriers reach high velocity
 - Knock electrons free
 - Create additional electron-hole pairs
 - Created pairs accelerated
 - Creates more electrons
 - “Avalanche” effect can damage diode

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Other Considerations

- Peak Inverse Voltage (PIV) or Peak Reverse Voltage (PRV) rating of diode

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Other Considerations

- Zener Breakdown
 - Heavily doped *n*-type and *p*-type materials in diode
 - Narrows depletion region
 - Increases electric field at junction
 - Electrons torn from orbit
 - Occurs at the Zener Voltage, V_Z

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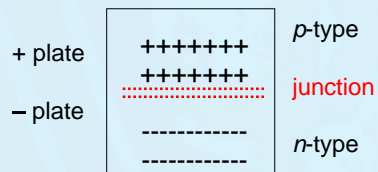
Other Considerations

- Zener Diodes
 - Designed to use this effect
 - An important type of diode

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Other Considerations

- Diode junction



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Other Considerations

- Like a capacitor
 - Thickness of depletion region changes with applied voltage
 - Capacitance dependent on distance between plates

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